



June 22, 2005

TO: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572  
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SUBJECT: Serial #: 10/614,928  
File Date: July 8, 2003  
Inventor: Jin-Yuan Lee  
Examiner: Menz, Douglas M.  
Art Unit: 2891  
Title: Structure of High Performance Combo Chip and Processing Method  
Customer Number: 28112

### PRELIMINARY AMENDMENT

Please enter the attached Preliminary Amendment.

### CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 23, 2005

Signature   
Stephen B. Ackerman, Reg. No. 37,761

Date: 6/23/05

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.